PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Katsuhiko Yamamoto	11/17/2009
Tadashi Terasaki	11/17/2009
Yoshiki Yonamoto	11/11/2009
Hirotaka Hamamura	11/17/2009

RECEIVING PARTY DATA

Name:	Hitachi Kokusai Electric Inc.
Street Address:	14-1, Sotokanda 4-chome, Chiyoda-ku
City:	Tokyo
State/Country:	JAPAN
Postal Code:	1018980

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12622816

CORRESPONDENCE DATA

Fax Number: (415)576-0300

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

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Correspondent Name: Roger Hylton

Address Line 1: Two Embarcadero Center, 8th Floor
Address Line 2: Townsend & Townsend & Crew

Address Line 4: San Francisco, CALIFORNIA 94111-3834

ATTORNEY DOCKET NUMBER:	16869U-242400US
NAME OF SUBMITTER:	Roger Hylton

Total Attachments: 2

PATENT REEL: 023831 FRAME: 0463 H \$40.00 12622

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PATENT REEL: 023831 FRAME: 0464

ASSIGNMENT (譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi Kokusai Electric Inc. a corporation organized under the laws of Japan,

located at 14-1, Sotokanda 4-chome, Chiyoda-ku, Tokyo 1018980, Japan

receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi Kokusai Electric Inc. its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

NON-VOLATILE SEMICONDUCTOR MEMORY DEVICE AND METHOD OF FABRICATING THE SAME

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be grant

to be held and enjoyed by said Hitachi Kokusai Electric Inc.

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi Kokusai Electric Inc.

Signed on the date(s) indicated aside our signatures:

	INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
1)_	Hatsuhiko Yamamoto (Katsuhiko YAMAMOTO)	November 17, 2009
2)_	Natsuhiko Yamamoto (Katsuhiko YAMAMOTO) Tadashi Terasaki (Tadashi TERASAKI)	November 17.2009
3).	(Yoshiki YONAMOTO)	
4).	(Hirotaka HAMAMURA)	
5).	•	
6)		
7)		
8)		
9)		
10)		

PATENT REEL: 023831 FRAME: 0465

ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi Kokusai Electric Inc.

a corporation organized under the laws of Japan,

located at 14-1, Sotokanda 4-chome, Chiyoda-ku, Tokyo 1018980, Japan

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invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be grant

to be held and enjoyed by said Hitachi Kokusai Electric Inc.

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi Kokusai Electric Inc.

Signed on the date(s) indicated aside our signatures:

RECORDED: 01/22/2010

INVENTOR(S)	
(発明者フルネームサイン)	

Date Signed (署名日)

1)_	(Katsuhiko YAMAMOTO)	
2)_	(Tadashi TERASAKI)	
3)_	TOSHIEL TO NAMO TO (Yoshiki YONAMOTO)	November. 11. 2009
4)_	Hirotaka Hamamura (Hirotaka HAMAMURA)	November. 17. 2009
5)_		
6)		
7)		
8)		
9)		
10)		

PATENT REEL: 023831 FRAME: 0466